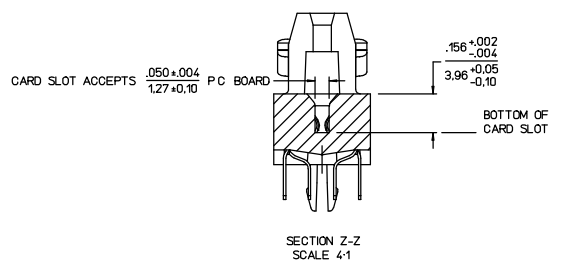


SOLDER TAIL OFFSET PATTERN BEGINS AT PIN NO. 1



CATALOG NUMBER DESCRIPTION

ELF 200 N S C R - 4 Z50

CONNECTOR SERIES
EXTREMELY LOW FORM FACTOR

NUMBER OF CONTACTS

BAY CONFIGURATION
N= 3 BAYS: 16/62/22 POSITIONS

TERMINATION STYLE
S= THRU-HOLE SOLDER TAILS

PLATING VARIATION

DESIGN VARIATION
4= FOR .093 ± .007 (1.57 ± 0.18) BACKPLANE APPLICATIONS.

EJECTOR STYLE
E= LEFT (BAY A)
R= RIGHT
B= BOTH
N= NONE

RETENTION STYLE
C= METAL CLIPS

- NOTES: UNLESS OTHERWISE SPECIFIED,
- INTERPRET THIS DRAWING IN ACCORDANCE WITH ANSI Y14.5M-1982.
 - COMPONENT BOARD MATERIAL:
P.C BOARD: FR-4 WITH 1 OZ [28.35g] MIN COPPER PADS.
PAD PLATING: 30 MICRONS [0.76 MICRONS] MIN. GOLD.
PER MIL-C-45204, TYPE 1, CLASS 1, GRADE C,
OVER 100 MICRONS [2.54 MICRONS] MIN NICKEL PER QQ-N-290.
 - SEE SHEET 2 FOR RECOMMENDED DAUGHTERCARD DETAILS.
 - SEE SHEET 3 FOR RECOMMENDED HOLE PATTERNS.

- DIMENSION APPLICABLE WHEN COMPONENTS MOUNTED ON BOTH SIDES.
- CARD THICKNESS APPLIES ACROSS THE CONTACT PADS. STRAIGHTNESS CALLOUT APPLIES TO ZONE DEFINED BY INDICATED DIMENSIONS AND OVERALL CARD WIDTH.
- WHEN SOJ DEVICES ARE USED FOR ASSEMBLY OF THIS MODULE THE MAXIMUM OVERALL THICKNESS SHALL NOT EXCEED .354 (9.00). WHEN TSOP DEVICES ARE USED THE MAXIMUM THICKNESS SHALL NOT EXCEED .157 (4.00).
- CHAMFERING OPERATION MUST NOT CUT INTO PLATED PADS.

MATERIAL:

BODY: GLASS FILLED THERMOPLASTIC, UL 94V-0, COLOR - BROWN.

EJECTOR: GLASS FILLED THERMOPLASTIC, UL 94V-0, COLOR-NATURAL.

CONTACTS: COPPER ALLOY.

RETENTION CLIPS: NICKEL PLATED COPPER ALLOY

CONTACT PLATING:

Z50 PLATING: GOLD FLASH OVER 15 MICRONS [0.38 MICRONS]
PALLADIUM-NICKEL OVER 50 MICRONS [1.27 MICRONS]
NICKEL UNDERPLATE IN CRITICAL CONTACT AREA AND
50 MICRONS [1.27 MICRONS] SOLDER OVER NICKEL
UNDERPLATE ON SOLDER TAILS.

PERFORMANCE CHARACTERISTICS:

CONTACT RESISTANCE: 30 MILLIOHMS MAXIMUM INITIAL, 10 MILLIOHMS MAXIMUM INCREASE THROUGH TESTING.

CONTACT NORMAL FORCE: 1.76 OZ. (50 GRAMS) MINIMUM END OF LIFE.

DURABILITY: 50 CYCLES AS PER MIL-C-21097

INSULATION RESISTANCE: 1000 MEGOHMS MINIMUM.

OPERATING TEMPERATURE: -13°F [-25°C] TO 185°F [85°C].

INSERTION FORCE: MIL-STD-1344, METHOD 2013.1, 7 OZ-FORCE (1.9 N)
MAX AVERAGE PER OPPOSING PAIR USING GAUGE PER
MIL-C-21097, EXCEPT .050 (1.20) THICK WITH
.003/.006 (0.08/0.15) RADII.

BOTH BODY AND CONTACTS ARE ABLE TO WITHSTAND VAPOR PHASE AND IR REFLOW TEMPERATURE EXPOSURES.

1	SH1 SECT Z-Z DIM .156 ± .002 - .004 WAS .172 ± .007 (ECON3670)	RS	JK	02-27-97
REV	REVISION DESCRIPTION	BY	CHKD	DATE

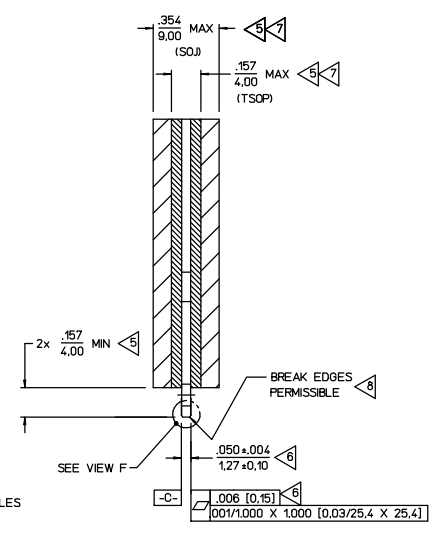
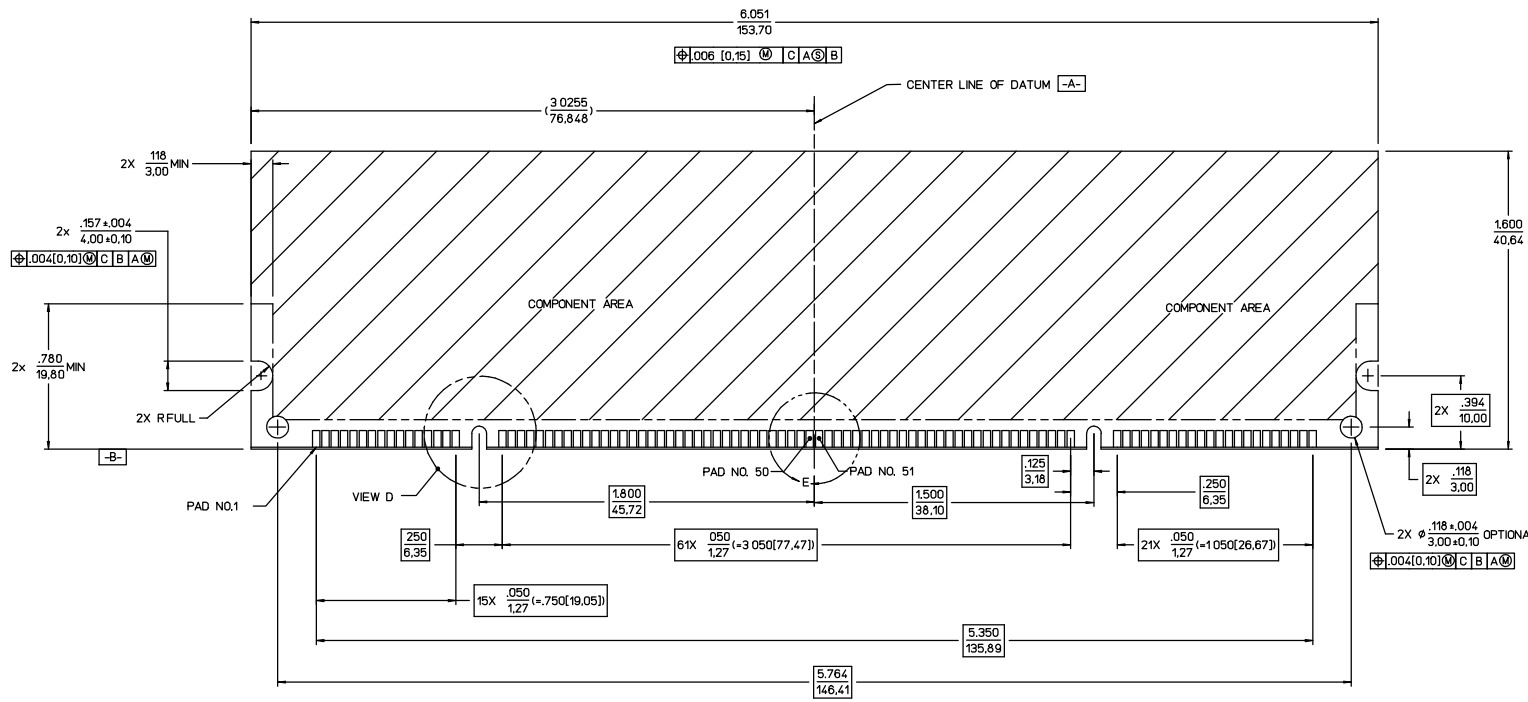
ELF CONNECTOR FOR SDRAM			
CAT NO ELF200NSCR-4Z50			
DWG RELEASED TO CENTRAL FILE 08-17-95			
CAGE NO 09922 DON 964 PC 723			
© FRAMATOME CONNECTORS USA INC.1995			
DRWIN	RPS	5-10-95	
CHKD	SMM	8-15-95	
DESIGN	SMM	8-17-95	
MKT	TK	8-17-95	
QC	JB	8-17-95	
DRAWING SCALE		2	1
DRAWING NO		SE96354	1
SHEET 1 OF 3			

LINEAR MEASURE:	INCH (mm)	INCH (mm)
THIRD ANGLE PROJECTION		
- TOLERANCES -		
UNLESS OTHERWISE SPECIFIED		
NO OF DECIMAL PLACES IN INCHES	INCH (mm)	
ONE PLACE	±.1 (.3)	
TWO PLACES	±.02 (.05)	
THREE PLACES	±.005 (.013)	
ANGLES ±°		

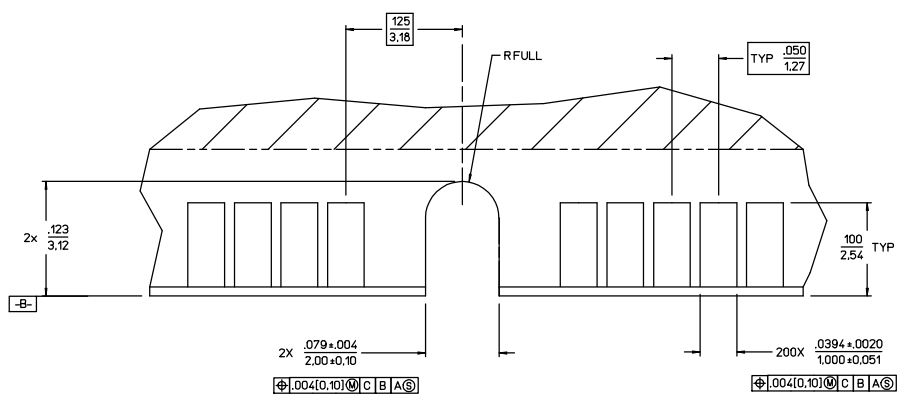


SUPERSEDES SKE30145-3

NOTES: SEE SHEET 1



RECOMMENDED DAUGHTERCARD FOR ELF200NSCR-4Z50



-	ALL REVS RECORDED ON SHEET 1	-	-	-
REV	REVISION DESCRIPTION	BY	CHKD	DATE

ELF CONNECTOR FOR SDRAM				
CAT NO ELF200NSCR-4Z50				
DWG RELEASED TO CENTRAL FILE 8-17-95				
CAGE NO 09922 DON 964 PC 723				
FRAMATOME CONNECTORS USA INC.1995				
DRWN	RPS	5-10-95		
CHKD	SMM	8-15-95		
DSGN	SMM	8-17-95		
MKT	TK	8-17-95		
QC	JB	8-17-95		
DRAWING SCALE 2:1				
DRAWING NO				
SE96354 1				
SHEET 2 OF 3				

LINEAR MEASURE:	INCH	INCH (mm)
THIRD ANGLE PROJECTION		
- TOLERANCES -		
UNLESS OTHERWISE SPECIFIED		
NO OF DECIMAL PLACES IN INCHES	INCH (mm)	
ONE PLACE	±.1 (±2.54)	
TWO PLACES	±.02 (±0.5)	
THREE PLACES	±.005 (±0.13)	
ANGLES ±°		



